

ELECTROWETTING-ON-DIELECTRIC ACTUATION OF A SPATIAL AND ANGULAR MANIPULATION MEMS STAGE

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ABSTRACT

We demonstrate a MEMS translational stage that uses electrowetting-on-dielectric (EWOD) as the actuating mechanism. Our EWOD stage is capable of linear translation with resolution of 10 μm over a maximum range of 130 μm and angular deflection of approximately $\pm 1^\circ$ while eliminating solid-solid contact. The range and resolution can be readily improved via higher base contact angle and lower contact angle hysteresis as indicated by the detailed modeling accompanying the experimental demonstration.

INTRODUCTION

Adhesion and friction during physical contact of solid components in MEMS often lead to device failure [1, 2]. Translational stages that have been fabricated with traditional silicon MEMS often face tribological concerns. Meanwhile, electrowetting, a phenomenon whereby the contact angle of a fluid can be changed with an applied voltage allowing control of droplet shape [3], has proved useful in MEMS applications ranging from fluid lenses for optical manipulation [4-7] to switches used for electrical [8, 9] and thermal control [10] and thermal management [11]. We show through modeling and experimental demonstration that EWOD has the potential to eliminate solid-solid contact during MEMS stage operation by actuating *via* deformable liquid droplets placed between the stage and base to achieve stage displacement as a function of applied voltage, shown schematically in Figure 1a. This operational mechanism is similar to the capillary force actuator, which relies on deformation of a liquid droplet between two solid surfaces and offers distinct advantages compared to other MEMS actuators [12]. While the actuation and dynamics [13, 14] of such devices have been explored theoretically, an experimental device without solid-solid contact has not been demonstrated, nor has angular deflection been shown [15].

MODEL

We developed an axisymmetric iterative numerical model for each of the four droplets in our device to determine the stage height as a function of the applied voltage for comparison with experimental results obtained from the working device. First, the contact angle at the EWOD base was determined with the Lippman-Young equation as a function of the intrinsic contact angle and applied voltage as well as the capacitive properties of the dielectric layer. Then, the droplet curvature in the system

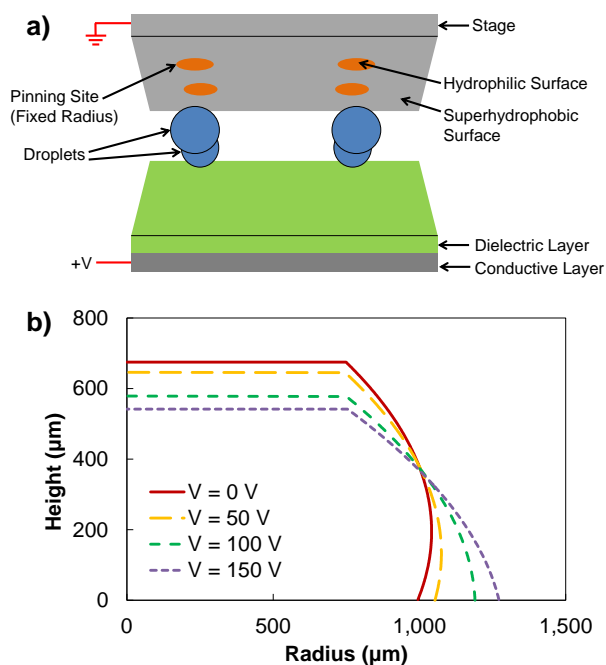


Figure 1: (a) The electrowetting-actuated stage is shown schematically. The tops of the water droplets contact the underside of the stage at electrically conducting hydrophilic copper pinning sites surrounded by a superhydrophobic surface of functionalized CuO nanoblades, and the bottoms of the droplets contact the insulated electrowetting-on-dielectric base. (b) The expected stage height is determined by our axisymmetric model. Model droplet profiles as a function of applied voltage are shown for a 2 μL droplet and base Young contact angle of 110° . Contact with the region of fixed radius on the underside of the stage corresponds to the flat regions at the top of the droplet profiles.

was calculated as a function of the internal Laplace pressure, which was determined at the top of the droplet (underside of the stage) by summing one quarter of the stage weight with the surface tension force pulling downwards along the pinned three-phase contact line at the perimeter of the droplet and then dividing that quantity by the fixed top contact area. Note that the droplet curvature relies on the initially unknown droplet contact angle at the underside of the stage; as such, an iterative solution was implemented. The complete droplet profile was determined numerically under the constant curvature constraint by iterating until convergence. The model was used to determine the profiles of droplets under different applied voltages, shown in Figure

1b. The flat region at the top of each profile is the contact with a pinning site on the bottom of the stage, where the constant radius over different applied voltages is consistent with the physical picture. The contact angle at this pinned region varies, as does the radius of the base on the EWOD surface, both of which are expected.

EXPERIMENT

We fabricated the stage by first growing rough copper oxide (CuO) nanoblades on copper foil following a common procedure detailed in the literature [16] and then functionalizing the CuO with a monolayer of trichloro(1H,1H,2H,2H-perfluorooctyl)silane (Sigma-Aldrich) to form a superhydrophobic surface. The advancing and receding contact angles of the superhydrophobic CuO were $172^\circ \pm 3^\circ$ and $168^\circ \pm 3^\circ$, respectively, as measured with a microgoniometer (MCA-3, Kyowa). The pinning sites were subsequently formed on the underside of the stage by milling away the CuO to a negligible depth using an end mill with a diameter of approximately 1.5 mm, thereby exposing the hydrophilic [17] copper and forming a liquid pinning site at the junction of the hydrophilic and superhydrophobic regions to fix the top radius of the droplets. Finally, to establish a non-constraining electrical connection with the stage, a copper wire was soldered in a vertical orientation to a tab at the corner of the stage in order to attach to a sliding attachment mounted above the stage. The total stage mass was 0.090 g.

Indium-tin-oxide-coated glass slides with resistivity of $10 \Omega/\text{sq}$ were used as the conductive substrate for the EWOD base. The slides were solvent and plasma cleaned, then coated with a $4 \mu\text{m}$ thick parylene-C layer (VSI Parylene, precision $\pm 1 \mu\text{m}$) with dielectric strength of 22,000 V/m and relative permittivity of $\epsilon_r \approx 3$. The slides were subsequently coated with a sub-micron coating of Teflon aqueous fluoropolymer (AF) as detailed in past work [18] in order to promote a high intrinsic contact angle ($\approx 116^\circ$) with low contact angle hysteresis. The water

contact angle at varying applied voltages on the EWOD base was characterized by applying voltage through a copper wire electrode inserted into a single $2 \mu\text{L}$ droplet of 0.1 mM KCl solution in water resting on the EWOD base. The EWOD base was electrically grounded with copper alligator clips penetrating through the dielectric coating to the ITO and subsequently mounted on the stage in front of the high-speed camera. The voltage was varied up to 150 V, and the contact angle was in excellent agreement with the Lippmann-Young prediction until the saturation voltage, which occurred at a contact angle of 74° for the Teflon AF coated parylene-C surface.

The experimental setup consisted of a function generator (AFG 3101, Tektronix) passed through a 400x voltage amplifier (A800, FLC Electronics) with the positive lead wired to the EWOD base and the negative lead attached to the stage via the sliding electrical connection to allow free translation in the vertical z-direction. The stage provided direct electrical connection to the droplets through the conductive hydrophilic copper circles on its underside.

The device was both front- and back-lit for high-speed video capture (Phantom v7.1, Vision Research) from 500 to 10,000 frames per second as the experiment was conducted. Four droplets of 0.1 mM KCl solution in water with a volume of $2 \mu\text{L}$ were carefully pipetted onto the pinning sites on the underside of the stage, which was then inverted and placed onto the EWOD base (the pinned droplets did not fall from the stage). Finally, the stage sliding electrical connection was attached for initial characterization.

Images during a typical experiment were captured in Figure 2. At an applied voltage of 150 V, the contact angle decreased from 116° to 74° on the Teflon AF coated EWOD base. This change in contact angle caused the droplets to spread while the volume remained constant and thus resulted in a decrease in stage height as predicted by the model. Tests at intermediate voltages in Figure 3 (black circles indicate results with the sliding electrical connection) show good agreement with the model prediction for a $2 \mu\text{L}$ droplet generated by the iterative solution.

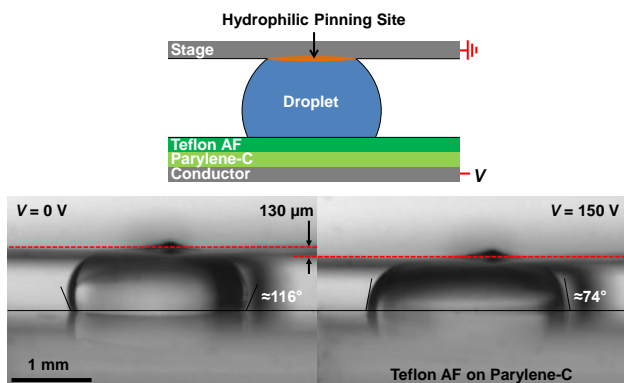


Figure 2: Schematic and photos of the initial neutral state and the stage vertical translation at an applied voltage of 150 V, which resulted in a stage deflection of $130 \mu\text{m}$ on using the Teflon AF-coated base surface compared to the initial neutral position (zoomed in to one droplet).

RESULTS

To eliminate solid-solid contact and the accompanying stiction and tribological concerns, the stage was reconfigured to remove the requirement for the sliding electrical connection. This was achieved by separating the Teflon AF coated EWOD base into two electrically insulated components, each holding two droplets (Figure 3). Then, voltage was applied from one insulated section of the EWOD base to the other, forming a circuit comprised of two capacitors (the dielectric regions at the base of the droplets on each of the insulated EWOD base sections). Since each of these series capacitors carry half of the applied voltage, twice the voltage required in the previous configuration is required for the same stage deflection. The stage deflection in this configuration was experimentally demonstrated to be equivalent to the previous (wired) configuration and in good agreement with the model, as shown in Figure 4b.

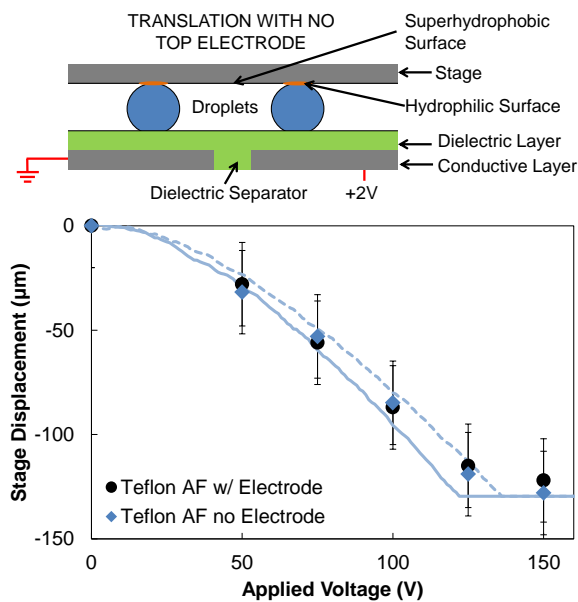


Figure 3: Elimination of the stage electrode is achieved by applying the voltage to two droplets in series from the base with a dielectric separator between two pairs of droplets and provides the same stage deflection as a function of voltage as the wired version, both of which are in excellent agreement with the model (solid and dashed line indicate lower- and upper-bound model predictions).

Additionally, the stage can provide angular deflection. The configuration was further modified to keep the electrically separated EWOD base but once again include the stage sliding electrical connection, which was grounded (Figure 4). When a voltage is applied to either insulated section of the EWOD base, that side of the stage is displaced downwards while the other side remains unperturbed, resulting in angular deflection. To test this configuration, we constructed a varying voltage that first actuated one side of the stage, and then actuated the other side of the stage. The function generator/amplifier output was set to increase from 0 V to 150 V and then decrease back to 0 V repeatedly as a sine wave with amplitude 75 V, offset +75 V, and period 2 sec. This signal was followed by a microcontroller (UNO R3, Arduino) which used a motor shield (L298P, Arduino) to switch relays (7266K64, McMaster-Carr) that alternated the applied voltage between the two sides of the EWOD base each time the signal bottomed out at 0 V, leaving the non-active side of the EWOD base at 0 V. The result of the signal applied to this configuration is shown in Figure 4, where each side of the stage deflected by approximately 130 μm when the voltage was applied (diamond and square symbols), in agreement with the uniform vertical stage displacement demonstrated previously, and the stage angular displacement varied from approximately -1° to $+1^\circ$ (hollow circular symbols).

Combining the two modified configurations above could yield an angular deflection stage that does not require any solid-solid contact (no stage electrode connection).

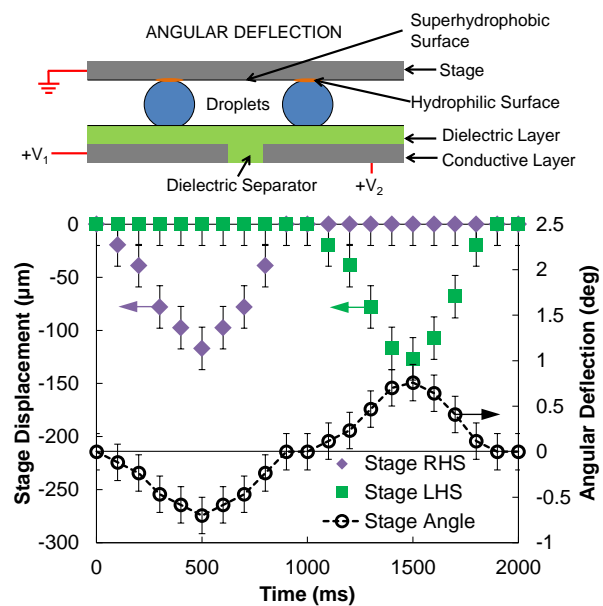


Figure 4: Angular deflection of the stage, achieved by applying a sinusoidal signal with differing voltages to the two isolated sections of the base while the stage is grounded, reached approximately one degree in the current configuration. These two approaches can be combined for angular deflection without a direct electrical connection to the stage, thus providing angular deflection without solid-solid contact.

This is possible by separating the EWOD base into four electrically isolated sections, one for each droplet, and then essentially controlling the deflection of two adjacent droplets by applying a voltage across the EWOD base beneath those droplets. Such a configuration would also allow angular deflection along any axis of rotation within the plane of the stage. A further expansion of this concept could build on past work in which the EWOD surface was separated into an array of isolated electrodes actuated separately to induce lateral droplet motion [19-21]. Operation of the stage described in the present work on such an array of electrodes could allow for lateral as well as vertical translation.

CONCLUSIONS

This work shows a MEMS vertical translation stage that uses EWOD as the actuating mechanism. The EWOD stage was capable of linear spatial manipulation with resolution of 10 μm over a maximum range of 130 μm , which can be readily improved in future device generations using the validated model developed in the present work as a guide. Specifically, a higher intrinsic contact angle on the EWOD base improves absolute range, and reduction of contact angle hysteresis, possibly by addition of a lubricant to the surface [22, 23] or careful control of contaminants [24], will increase resolution. In addition, angular deflection of approximately $\pm 1^\circ$ was demonstrated, and the maximum range and angular deflection are comparable to an alternate

type of actuator, piezoelectrics. The capability to operate the stage without any solid-solid contact makes this a desirable potential solution to stiction and tribology concerns for improvement of applications in micro-optics, actuators, and other MEMS.

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